

#### 1.6x1.6mm FULL-COLOR SURFACE MOUNT **LED**

PRELIMINARY SPEC



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE

**DEVICES** 

Part Number: APTF1616SEEVGAPBAC

Hyper Orange Green

#### **Features**

- 1.6mmX1.6mm SMT LED, 0.7mm THICKNESS
- LOW POWER CONSUMPTION
- ONE BLUE, ONE RED AND ONE GREEN CHIPS IN ONE PACKAGE
- CAN PRODUCE ANY COLOR IN VISIBLE SPEC-TRUM, INCLUDING WHITE LIGHT
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- RoHS COMPLIANT.

### Description

The Hyper Orange source color devices are made with InGaAIP on GaAs substrate Light Emitting Diode.

The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

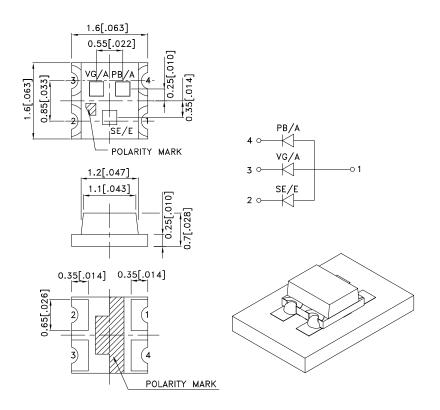
The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

# **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. Specifications are subjected to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





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## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APTF1616SEEVGAPBAC	Hyper Orange (InGaAIP)		180	400	120°
	Green (InGaN)	WATER CLEAR	70	180	
	Blue (InGaN)		10	40	

#### Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device Typ.		Max.	Units	<b>Test Conditions</b>	
λpeak	Peak Wavelength	Hyper Orange Green Blue	630 520 468		nm	IF=20mA	
λD [1]	Dominant Wavelength	Hyper Orange Green Blue	621 525 470		nm	IF=20mA	
Δλ1/2	Spectral Line Half-width	Hyper Orange Green Blue	20 35 21		nm	IF=20mA	
С	Capacitance	Hyper Orange Green Blue	25 100 100		pF	Vr=0V;f=1MHz	
VF [2]	Forward Voltage	Hyper Orange Green Blue	2 3.2 3.2	2.5 4 4	V	IF=20mA	
lr	Reverse Current	Hyper Orange Green Blue		10 10 10	uA	VR=5V	

#### Notes:

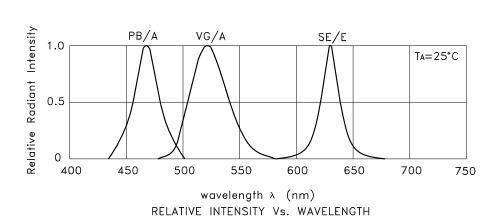
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

# Absolute Maximum Ratings at TA=25°C

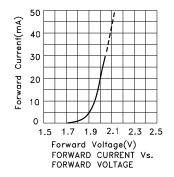
Parameter	Hyper Orange	Green	Blue	Units		
Power dissipation	75	120	120	mW		
DC Forward Current	30	30	30	mA		
Peak Forward Current [1]	195	100	100	mA		
Reverse Voltage		5		V		
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

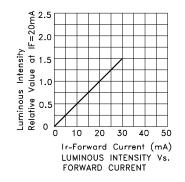
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

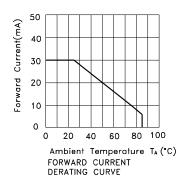
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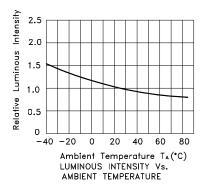


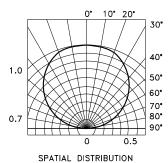
# **APTF1616SEEVGAPBAC Hyper Orange**







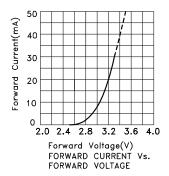


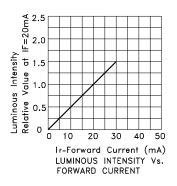


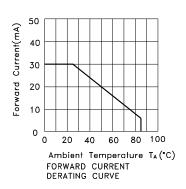
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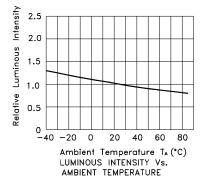
 APPROVED: WYNEC
 CHECKED: Allen Liu
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## Green



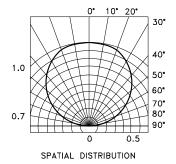






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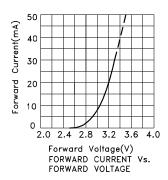
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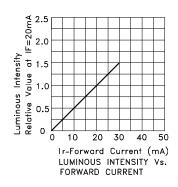


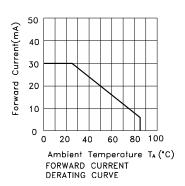
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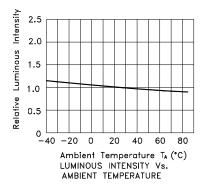
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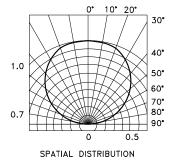
## Blue









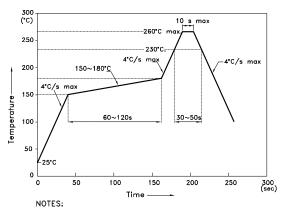


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### **APTF1616SEEVGAPBAC**

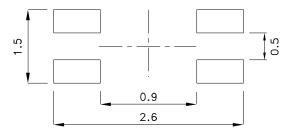
Reflow Soldering Profile For Lead-free SMT Process.



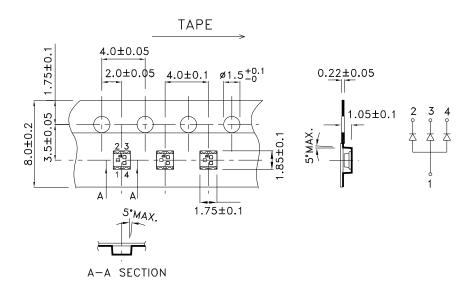
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
   3.Number of reflow process shall be 2 times or less.

# **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



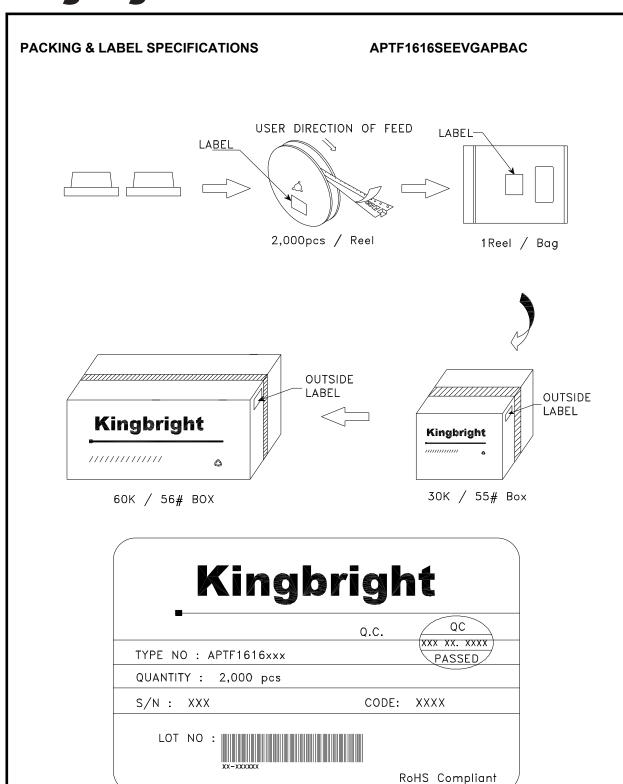
## **Tape Specifications** (Units: mm)



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